

CURRENT 1.0 Ampere
 VOLTAGE RANG 50 to 1000 Volts

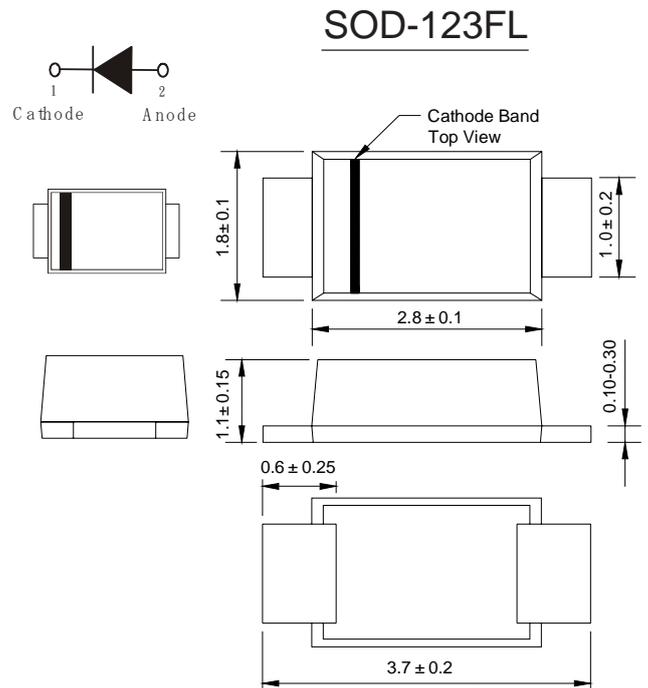
A1 THRU A7

FEATURES

- Glass passivated device
- Ideal for surface mouted applications
- Low reverse leakage
- Metallurgically bonded construction
- High temperature soldering guaranteed:
 250°C/10 seconds, 0.375" (9.5mm) lead length,
 5 lbs. (2.3kg) tension

MECHANICAL DATA

- Case: JEDEC SOD-123FL molded plastic body over passivated chip
- Terminals: Solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Mounting Position: Any
- Weight: 0.0007 ounce, 0.02 grams



Dimensions in millimeters

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

- Rating at 25 ambient temperature unless otherwise specified.
- Single phase, half wave ,60Hz, resistive or inductive load.
- For capacitive load, derate current by 20%

TYPE NUMBER		D1	D2	D3	D4	D5	D6	D7	UNITS
		A1	A2	A3	A4	A5	A6	A7	
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current @T _A =75	I(AV)	1.0							A
Peak Forward Surge Current 8.3ms Single Half Sine-Wave Super Imposed on Rated Load(JEDEC Method)	I _{FSM}	30							A
Maximum Forward Voltage at 1.0A DC	V _F	1.1							V
Maximum DC Reverse Current @T _J =25 at Rated DC Blocking Voltage @T _J =100	I _R	5 50							μA
Typical Junction Capacitance (Note1)	C _J	10							pF
Typical Thermal Resistance (Note2)	R _{JA}	30							/W
Operating Temperature Range	T _J	-55 to +125							
Storage Temperature Range	T _{STG}	-55 to +125							

NOTES: 1. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.
 2. Thermal resistance junction of ambient.

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RATING AND CHARACTERISTIC CURVES A1 Thru A7

FIG.1- MAXIMUM FORWARD CURRENT DERATING CURVE

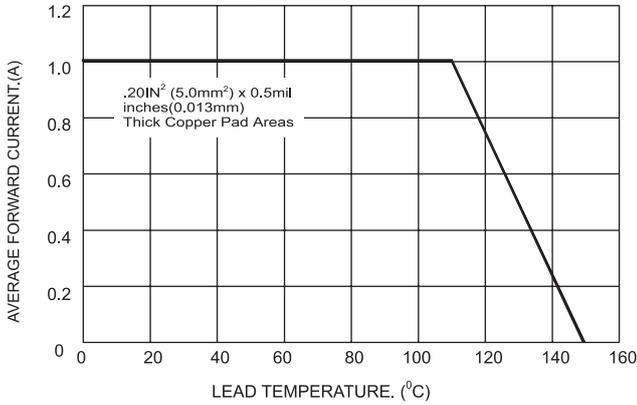


FIG.2-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

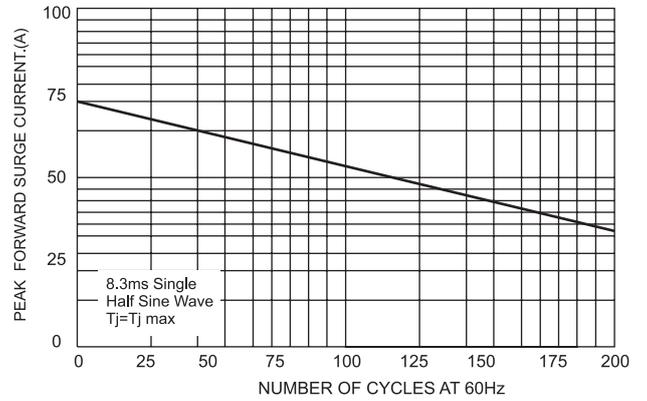


FIG.4-TYPICAL REVERSE CHARACTERISTICS

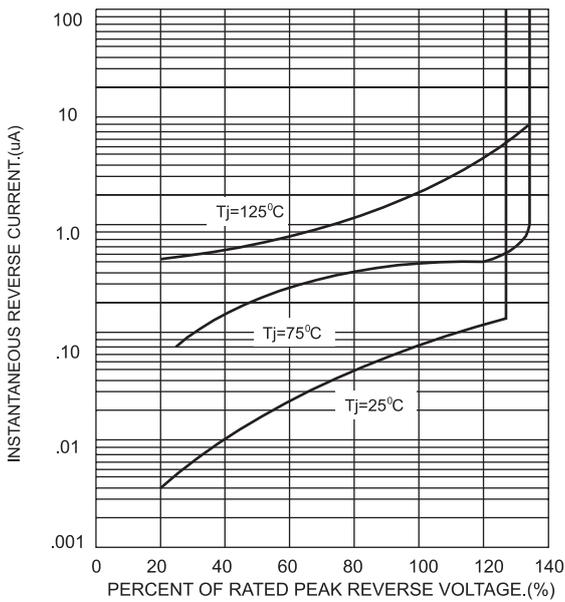


FIG.3-TYPICAL FORWARD CHARACTERISTICS

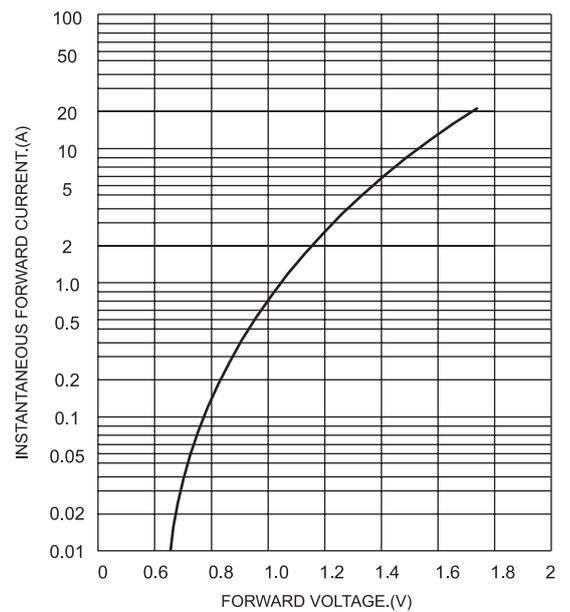


FIG.5-TYPICAL JUNCTION CAPACITANCE

